

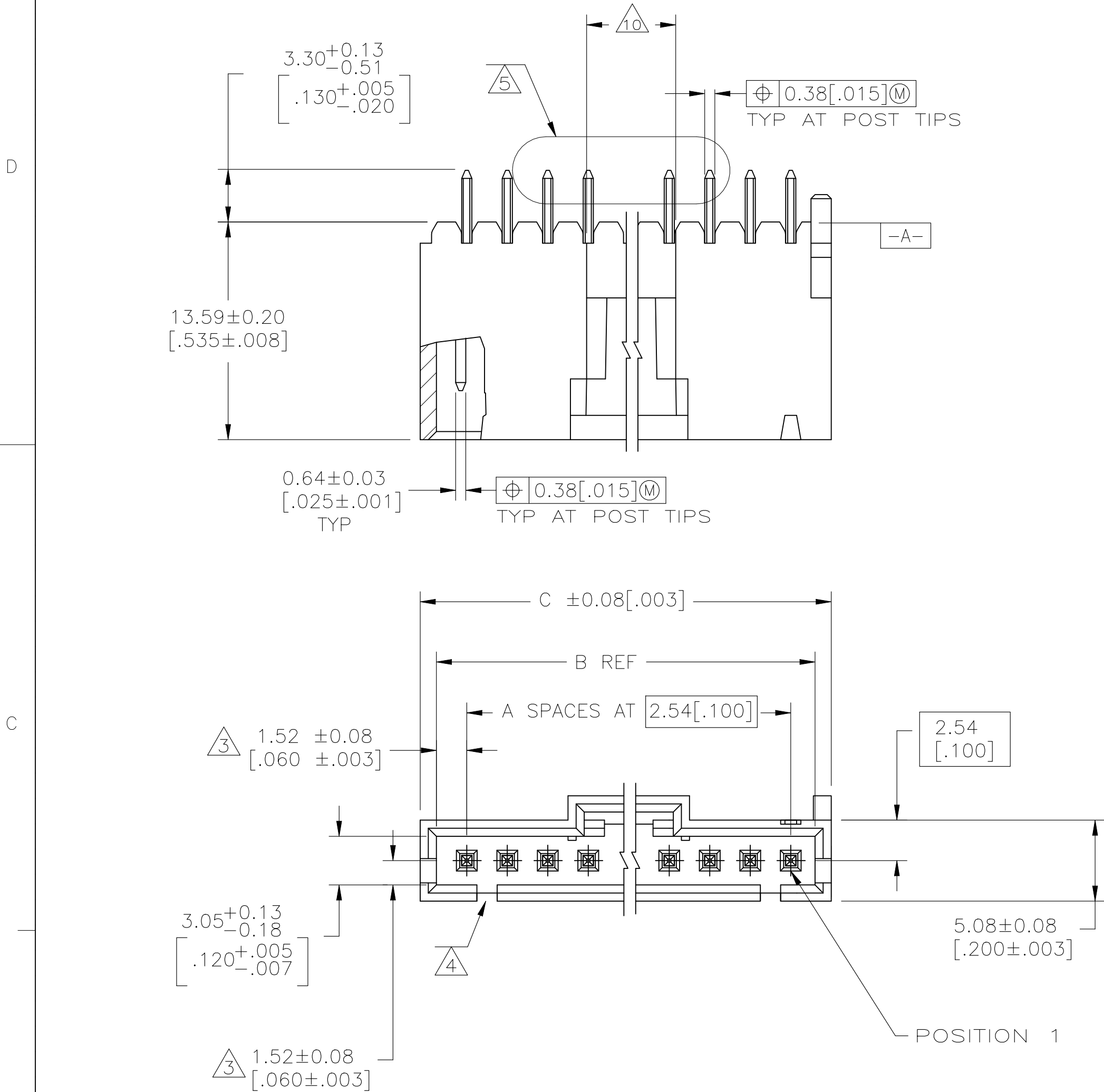
REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
C		REVISED PER ECO-20-001912	03JUN2020	SB	JO

D

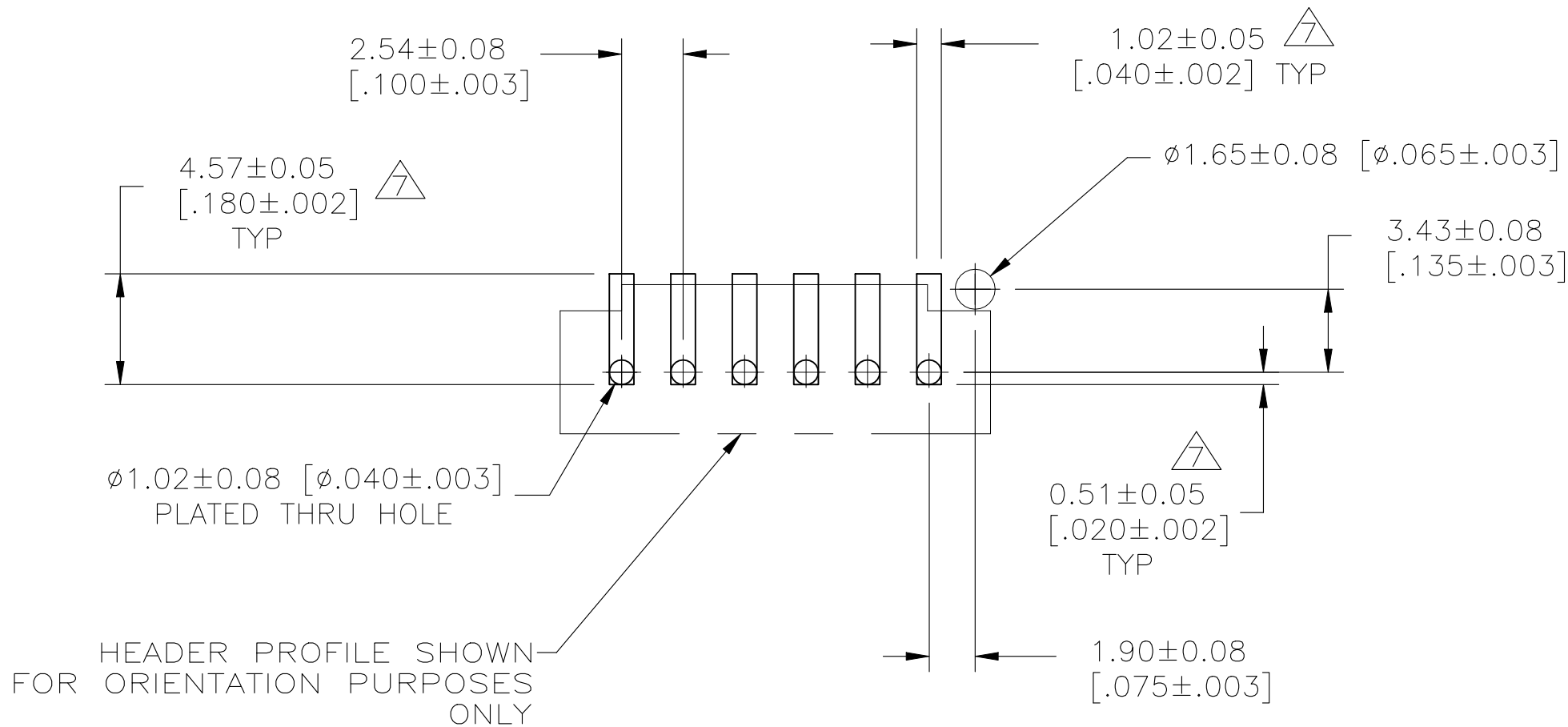
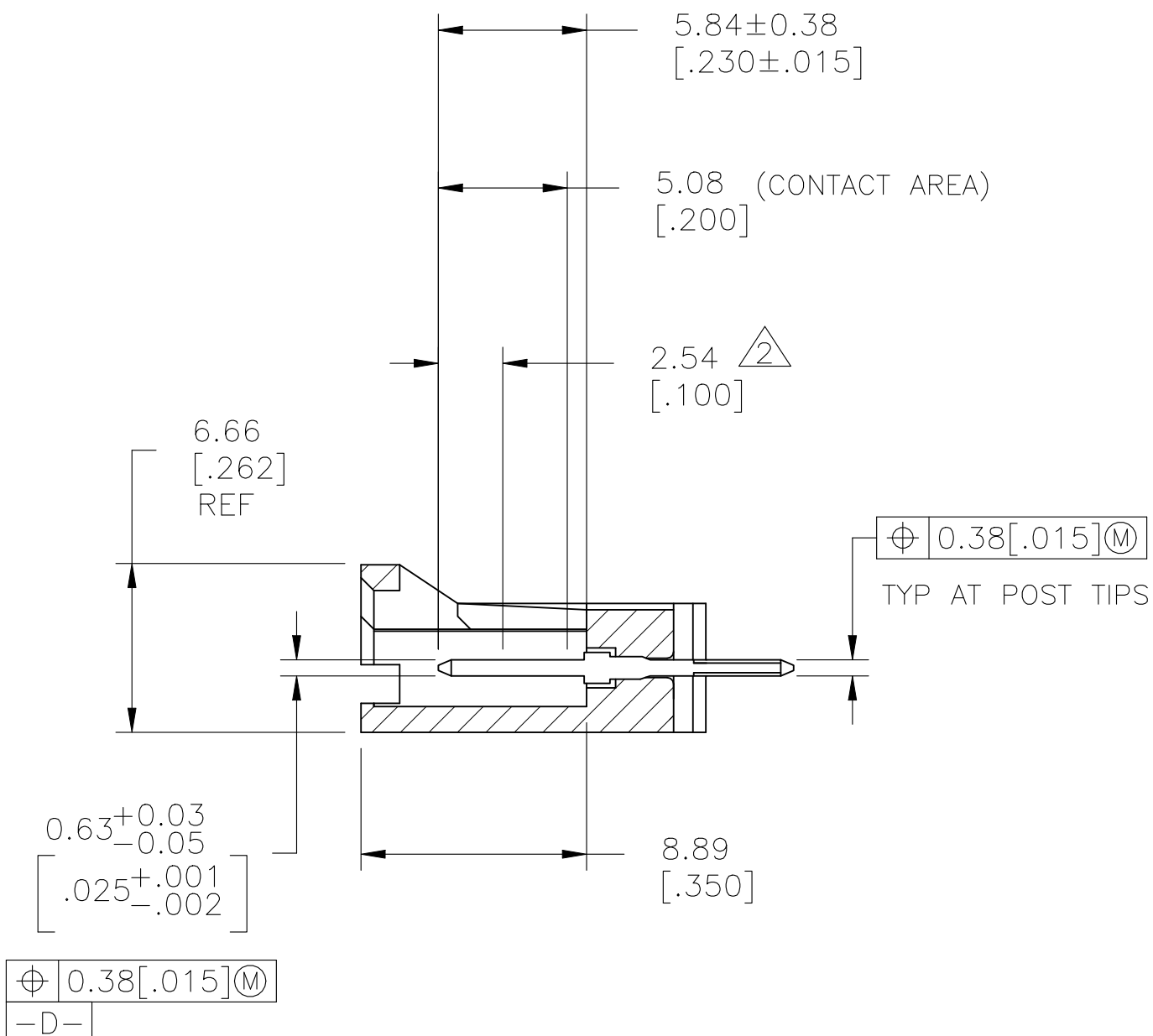
C

B

A



DETAIL Z
POST DETAIL TYP
2 POST MINIMUM



RECOMMENDED PC BOARD MOUNTING DIMENSIONS
RECOMMENDED STENCIL THICKNESS = 0.25[.010]

- 1 FINISH: .00076[.000030] GOLD IN THE CONTACT AREA, .00254[.000100] MATTE TIN PLATING ON REMAINDER OF CONTACT, ALL OVER .00127[.000050] NICKEL.
- 2 POINT OF MEASUREMENT FOR PLATING THICKNESS.
- 3 THE NOTED DIMENSIONS APPLY FROM THE BASIC DIMENSION CENTER LINE (NOT THE POST CENTER LINE) TO THE SURFACE INDICATED.
- 4 ONE POLARIZATION SLOT FOR 2 POSITION ASSEMBLY ONLY.
- 5 SELECT POST TAILS FORMED TO PROVIDE CONNECTOR HOLD DOWN UNTIL SOLDERED, CONFIGURATION ACCEPTS 0.69[.027]–2.03[.080] THICK PRINTED CIRCUIT BOARD. (SEE DETAIL Z).
6. PARTS ARE PACKAGED IN GANG OF TUBES.
- 7 DIMENSIONS NOTED ARE FOR SOLDER STENCIL LAYOUT FOR USE WITH 1.58±0.20[.062±.008] THICK PRINTED CIRCUIT BOARDS.
- 8 MATERIAL– HOUSING: HIGH TEMP THERMOPLASTIC, COLOR–BLACK. POSTS: BRASS.
- 9 OBSOLETE PARTS.
- 10 0.25 [.010] RECESS PERMISSIBLE IN THIS AREA FOR MOLD SHUT OFF

9	22.86 [.900]	20.83 [.820]	7	8	1571513-4
9	20.32 [.800]	18.29 [.720]	6	7	1571513-3
9	10.16 [.400]	8.13 [.320]	2	3	1571513-2
	7.62 [.300]	5.59 [.220]	1	2	1571513-1
	C	B	A	NO. OF POSN	PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN R BROWN	07APR03	TE Connectivity	
		CHK J GESFORD	07APR03		
DIMENSIONS: mm[INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD J GESFORD		NAME PLZD HDR ASSY, AMPMODU MTE, VERTICAL SINGLE ROW, 2.54[.100] GL, 0.64[.025] SQ POSTS, WITH LATCHING-& HOLD DOWN	
		PRODUCT SPEC		APPLICATION SPEC	
	0. PLC ± - 1. PLC ± - 2. PLC ± 0.13[.005] 3. PLC ± - 4. PLC ± - ANGLES ± -	SIZE		RESTRICTED TO	
		WEIGHT		CUSTOMER DRAWING	
MATERIAL	FINISH	A100779C=1571513		SCALE 4:1 SHEET 1 OF 1 REV C	